Impact of Orientation Misalignments on Black Phosphorus Usralcaled Field-effect Transistors

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Abstract—Two-dimensional materials with strong bandstructure anisotropy such as black phosphorus (BP) have been identified as attractive candidates for logic application due to their potential high carrier velocity and large density-of-states. However, perfectly aligning the source-to-drain axis with the desired crystal orientation remains an experimental challenge. In this paper, we use an advanced quantum transport approach from first-principle to shed light on the influence of orientation misalignments on the performance of BP-based field-effect transistors. Both n- and p-type configurations are investigated for six alignment angles, in the ballistic limit of transport and in the presence of electron-phonon and charged impurity scattering. It is found that up to deviations of $50^\circ$ from the optimal angle, the ON-state current only decreases by 30%. This behavior is explained by considering a single bandstructure parameter, the effective mass along transport direction.

Index Terms—2D materials, black phosphorus, transistors, bandstructure anisotropy, device simulation

I. INTRODUCTION

2D MATERIALS have received a wide attention from the scientific community ever since the discovery of graphene in 2004 [1]. The necessity of a band gap for logic applications ultimately led experimental efforts towards other 2D materials such as transition metal dichalcogenides (TMDs) e.g. MoS$_2$ [2] black phosphorus (BP) [3]–[5]. The latter material emerged as a serious contender due to its anisotropic bandstructure that simultaneously provides high carrier velocities and large density-of-states (DOS) [6]–[8], two properties that have been leveraged to design various types of more-than-Moore logic switches [9], [10].

Recent theoretical studies [11], [12] suggest that many other 2D materials with strong anisotropic conduction (CB) and/or valence band (VB) exist, e.g. $\text{Ag}_2\text{N}_6$, $\text{S}_6\text{Te}_4\text{Zr}_2$ or $\text{P}_8\text{Si}_4$. In their mono-layer form, when used as the channel material of ultra-scaled field-effect transistors, such compounds might exhibit almost ideal electrostatic characteristics as well as very high ON-state currents, if the transport direction is aligned with the proper crystal axes, i.e. the one with the lowest effective mass. However, from an experimental point of view, obtaining such perfect alignments is extremely challenging. If transport occurs along the crystal axis with the largest effective mass, device simulation predicts severe performance degradations for BP [13]–[15]. Most studies focused on the best- and worst-case scenarios, very few on what happens in between [16].

Here, we therefore study the impact of orientation misalignments on the ON-state current of ultra-scaled BP-FETs in their n- and p-type configuration. An advanced quantum transport solver combining density-functional theory (DFT) and the Non-equilibrium Green’s Function formalism (NEGF) is employed for that purpose. After introducing this simulation approach in Section II, it is revealed in Sections III that orientation misalignments up to 50$^\circ$ from the ideal case do not significantly alter the ON-state current of BP-FETs, with minor performance loss up to a misalignment angle of 20$^\circ$. This behavior, which occurs both in the ballistic limit of transport and in the presence of electron/hole-phonon and charged impurity scattering, is explained based on the calculation of angle-dependent effective masses.

II. APPROACH

The simulation results reported in this paper were obtained with an atomistic quantum transport solver [17] based on the NEGF equations following the same methodology as in [12]. An ab initio scheme is employed to capture the electronic band structure of BP and to create a suitable Hamiltonian matrix for the device geometry of interest. This step is achieved by converting the electronic structure received from a DFT package such as VASP [18] from a delocalized plane-wave basis to a set of maximally localized Wannier functions (MLWF) using the Wannier90 code [19]. The Hamiltonian of any unit cell can now be constructed by identifying the Wannier interaction for each atomic bond [20]. To minimize the computational burden, transport is evaluated along directions leading to reasonably small orthorhombic unit cells.

As exchange correlation functional the general gradient approximation of Perdew Burke Ernzerhof [21] is used. The PBE approximation
band gap of BP, \( E_g^{PBE} = 0.91 \text{ eV} \), is raised to the value obtained by the GLLBsc functional \( [22] \), \( E_g^{GLLBsc} = 1.40 \text{ eV} \) to avoid artificial source-to-drain tunneling in the OFF-state. This increase is justified by the systematic underestimation of the semiconductor band gaps by the PBE functional. The resulting bandstructure of BP, before and after the MLWF transformation is shown in Fig. 1(a) demonstrating the accuracy of the approach. A contour plot of the lowest conduction band is depicted in Fig. 1(b). The optimal performance is obtained when the transport axis is aligned with the \( \Gamma - X \) axis, while \( \delta \) indicates the misalignment angle.

As scattering is known to influence electron and hole transport in BP transistors \( [6, 23] \), the NEGF model of \( [24] \) inspired by the specifications of the International Roadmap for Devices and Systems, as shown in Fig. 2(a). A gate length \( L_g = 15 \text{ nm} \) was chosen to minimize source-to-drain leakages, which are not the subject of this study. All devices have a total length \( L_{tot} = 40 \text{ nm} \). The top oxide has an equivalent oxide thickness \( EOT = 0.6 \text{ nm} \) that ensures an excellent electrostatic control. Source and drain extensions are doped with a donor/acceptor carrier concentration of \( 5 \times 10^{13} \text{ cm}^{-2} \). We found that such high values do not artificially boost the ON-current \( [12] \). The OFF-state current if fixed to \( 0.1 \mu A/\mu m \).

All simulations were carried out at a supply voltage \( V_{ds} = 0.7 \text{ V} \) and at room temperature. In Fig. 2(a) only the P atoms belonging to the 2-D channels enter the NEGF framework. The other layers are accounted for through Poisson’s equations. The source and drain contact resistances are assumed to be negligibly small. Realistic top or side contacts might influence the dependence of the current on the transport direction, but adding them is not compatible with the chosen MLWF approach where the same unit cell is repeated to construct the device channel. Similarly, other potentially relevant effects such as the formation of direction-dependent crystal or edge defects are not considered here because their treatment significantly increases the computational burden.

Six different transport directions with a misalignment angle \( \delta \in \{0^\circ, 20^\circ, 36^\circ, 55^\circ, 71^\circ, 90^\circ\} \) w.r.t. the optimal direction are considered. The ON-state currents of the different \( n \)- and \( p \)-type transistors are reported in Fig. 2(b) as a function of \( \delta \), with and without CIS and electron/hole-phonon scattering. For simplicity, the electrostatic potentials without scattering are used in both types of calculation. Finally, to enable rapid convergence of the NEGF calculations, small impurity concentrations of \( N_{imp} = 2.5 \times 10^{11} \text{ cm}^{-2} \) are assumed in all cases.

The corresponding \( I_d - V_{gs} \) ballistic transfer characteristics are given in Figs. 2(c) and (d). It can be observed that the ON-state currents do not vary much for \( \delta \leq 20^\circ \), even in the presence of scattering. Moreover, the current reduction, as compared to the highest possible value is limited to 30% for misalignment \( \delta \leq 50^\circ \). The current degradation then rapidly increases to reach 60% or more at \( \delta = 90^\circ \). This finding demonstrates that the performance loss does not linearly depend on the misalignment angle, thus allowing for a certain tolerance during the fabrication process.

The non-linear dependence of the ON-state current on the transport direction does not appear to be a consequence of CIS or electron/hole-phonon scattering, as confirmed by the corresponding electron and hole low-field mobility in Fig. 3(a). This quantity, calculated with the “d\( r/dL \)” method \( [27] \), exhibits a similar behavior as the ON-state current. It stays almost constant up to 20\(^\circ\), slightly decreases between 20\(^\circ\) and 36\(^\circ\), before experiencing a faster reduction at greater angles. The same happens if the impurity concentration is increased to \( N_{imp} = 1 \times 10^{12} \text{ cm}^{-2} \). These results tend to indicate that the non-linearity of the current is an intrinsic property of BP directly coming from its bandstructure.

To reveal the role played by the BP bandstructure, we start by extracting relevant physical quantities at the top-of-the-barrier location (ToB) of the simulated FETs according to \( [12] \). First, we observed that the charge at the ToB is about \( \approx 15 \text{ nm} \) was chosen to minimize source-to-drain leakages, and at room temperature. In Fig. 2(a) only the P atoms belonging to the 2-D channels enter the NEGF framework. The other layers are accounted for through Poisson’s equations. The source and drain contact resistances are assumed to be negligibly small. Realistic top or side contacts might influence the dependence of the current on the transport direction, but adding them is not compatible with the chosen MLWF approach where the same unit cell is repeated to construct the device channel. Similarly, other potentially relevant effects such as the formation of direction-dependent crystal or edge defects are not considered here because their treatment significantly increases the computational burden.

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The ON-state current variations can be explained by ap-
proximating the \( E(\vec{k}) \) bandstructure dispersion of the lowest conduction band or the highest valence band as a parabola with a \( \delta \)-dependent inverse effective mass tensor \( (1/m_\delta) \)
\[
E(\vec{k}) = E_0 \pm \frac{\hbar^2}{2} \frac{\vec{k}^T}{m_\delta} \frac{\vec{k}}{m_\delta}.
\]

The \( +/\) sign refers to the electron/hole case, the energy \( E_0 \) either to the CB minimum or VB maximum, and \( \hbar \) to Plank’s reduced constant. In Eq. 1 \( 1/m_\delta \) is defined as
\[
\frac{1}{m_\delta} = R_\delta^2 \left( \frac{1}{m_\delta=0^\circ} \right) R_\delta, \quad R_\delta = \begin{pmatrix}
\cos \delta & \sin \delta \\
-\sin \delta & \cos \delta
\end{pmatrix}
\]
where \( R_\delta \) is a rotation matrix and \( m_\delta=0^\circ = diag(m_{\Gamma-X}^{-1}, m_{\Gamma-Y}^{-1}) \), the inverse effective mass tensor for transport along the \( \Gamma - X \) direction with \( m_{\Gamma-X} = 0.16m_0 \) (0.14\( m_0 \)), and \( m_{\Gamma-Y} = 1.20m_0 \) (4.46\( m_0 \)) for electrons (holes). These effective masses were extracted as in [12] for an electron/hole population of \( \sim 1.5e13 \text{ } \text{cm}^{-2} \).

The transport effective mass \( m_t(\delta) \) along any direction can be computed from Eq. 2 as [9]
\[
\frac{1}{m_t(\delta)} = \frac{\sin^2 \delta}{m_{\Gamma-Y}} + \frac{\cos^2 \delta}{m_{\Gamma-X}}
\]

By combining Eq. 1 and 2 the 2D DOS can be written as
\[
DOS_{2D}(\epsilon) = \frac{\sqrt{m_{\Gamma-X} m_{\Gamma-Y}}}{\pi\hbar^2} H(\pm(\epsilon - E_0))
\]

Here, \( H \) is the Heavy-side function. It can be seen that the DOS only depends on the effective masses along the principle axes of the ellipses describing the bands, not on \( \delta \). This is why the gate capacitance, and the electrostatics too, are the same for all transport directions.

Next, an analytical expression is derived for the \( \delta \)-dependent current
\[
I(\delta) = \frac{e_0}{\pi \sqrt{m_t(\delta)}} \int d\epsilon \; DOS_{2D}(\epsilon) f(\epsilon, \epsilon_{F,S}) \times \sqrt{\frac{\epsilon - E_0}{\epsilon_{TOB}} - \frac{\epsilon - E_0}{\epsilon_{TOB}}}
\]
where \( e_0 \) is the elementary charge, \( \epsilon_{TOB} \) the \( V_{GS} \)-dependent shift of the ToB energy, \( f(\epsilon, \epsilon_{F,S}) \) the Fermi distribution function, and \( \epsilon_{F,S} \) the Fermi level in the source. From Eq. 5 it can be inferred that the current \( I_\delta \) should linearly depend on \( 1/\sqrt{m_t(\delta)} \) because the DOS is the same for all misalignment angles. This linear dependence can be observed in Fig. 3(b), where the ON-state currents from Fig. 2(b) are reported.

We then use Eq. 4 and 5 to extract \( m_{DOS} \) and \( m_t(\delta) \), following the procedure outlined in [12]. The results are compared to \( m_t(\delta) \), as calculated with Eq. 4 in Fig. 3(c). An excellent agreement is observed. Key point is that \( m_t(\delta) \) exhibits a plateau for \( \delta \leq 20^\circ \), which reflect into an almost stable current in this range. Hence, Figs. 3(b) and (c) validate the form of Eq. 5.

The latter is finally recalled to compute the misalignment-induced current reductions w.r.t. to the maximum current value for any 2D material with an ellipsoidal bandstructure similar to BP. A map of the current reductions as a function of the \( m_{\Gamma-X}/m_{\Gamma-Y} \) ratio and the misalignment angle \( \delta \) is presented in Fig. 3(d) under the assumption of a fixed DOS. It can be shown that for \( m_{\Gamma-X}/m_{\Gamma-Y} < \) 0.1 the ON-state current only marginally decreases up to \( \delta \leq 20^\circ \), by 25\% if the misalignment is pushed to 40\%. It is clear that the magnitude of the ON-state current depends on the DOS of each 2D material. Nevertheless, a region where the current is almost insensitive to the misalignment angle can be expected in all cases.

IV. CONCLUSION

The effect of orientation misalignment caused by bandstructure anisotropies has been studied for \( n^- \) and \( p^- \) type black phosphorus FETs. A reduction of the ON-state current below 30\% is found for misalignment angles \( \delta \leq 50^\circ \), while the performance remains excellent for \( \delta \leq 20^\circ \), with and without scattering. The effective mass along the transport direction explains this behavior, which does not display a strong dependence on electron/hole-phonon and charged impurity scattering. For materials with a similar ellipsoidal bandstructure as BP, regardless of the \( m_{\Gamma-X}/m_{\Gamma-Y} \) ratio, minor current degradations are foreseen for misalignment angles \( \delta \) up to 20\%.

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